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IP4242CZ6 ESD protection for high-speed interfaces Rev. 01 — 12 March 2009

Product data sheet

1. Product profile

1.1 General description

The IP4242CZ6 is designed to protect high-speed interfaces such as HDMI, DVI and DisplayPort interfaces. The device includes high-level ElectroStatic Discharge (ESD) protection diodes for the TMDS signal lines.

All TMDS intra-pairs are protected by a special diode configuration offering a low line capacitance of only 0.9 pF. These diodes provide protection to downstream components from ESD voltages up to ± 8 kV contact according to IEC 61000-4-2, level 4.

1.2 Features

- Pb-free, RoHS compliant and free of Halogen and Antimony (Dark Green compliant)
- ESD protection for HDMI
- All TMDS lines with integrated rail-to-rail clamping diodes for downstream ESD protection of ±8 kV according to IEC 61000-4-2, level 4
- Matched 0.5 mm trace spacing
- Line capacitance of only 0.9 pF for each channel
- 2-channel, 6-terminal UTLP
- HDMI 1.3a compliant
- DisplayPort compliant

1.3 Applications

The IP4242CZ6 is designed for HDMI receiver and transmitter port protection:

- TVs, monitors
- DVD recorders and players
- Notebooks, main board graphics cards and ports
- Set-top boxes and game consoles



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2. Pinning information

Table	1. Pinning			
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	TMDS_CH1-	negative channel 1 ESD protection		
2	TMDS_CH1+	positive channel 1 ESD protection		
3	GND	ground		
4	GND	ground		$\Box \Box $
5	n.c.	not connected		本 本
6	n.c.	not connected	bottom view	3, 4
				001aaj776

3. Ordering information

Table 2. Ord	ering inform	nation	
Type number	Package		
	Name	Description	Version
IP4242CZ6	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body $1 \times 1.45 \times 0.5$ mm	SOT886

4. Limiting values

Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
VI	input voltage		GND – 0.5	+5.5	V
V _{esd}	electrostatic discharge voltage	all pins to ground; IEC 61000-4-2, level 4; contact discharge	-8	+8	kV
T _{stg}	storage temperature		-55	+125	°C
T _{amb}	ambient temperature		-40	+85	°C

5. Characteristics

Table 4.	Characteristics						
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
V_{BRzd}	Zener diode breakdown voltage	I = 1 mA	[1]	6	-	9	V
I _{LRzd}	Zener diode reverse leakage current	per TMDS channel; $V = 3.0 V$		-	-	1	μΑ
V _F	forward voltage			-	0.7	-	V
$C_{\text{ch}(\text{TMDS})}$	TMDS channel capacitance	f = 1 MHz; V_{bias} = 2.5 V	[1]	-	0.9	-	pF
$\Delta C_{ch(TMDS)}$	TMDS channel capacitance difference	f = 1 MHz; V_{bias} = 2.5 V	[1]	-	0.15	-	pF
$C_{ch(mutual)}$	mutual channel capacitance	between signal pin and pin n.c.; f = 1 MHz; V _{bias} = 2.5 V	<u>[1]</u>	-	0.15	-	pF

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Table 4.	Characteristics continued					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{dyn}	dynamic resistance	I = 1 A; T_{amb} = 25 °C; IEC 61000-4-5/9				
		positive transient	-	2.4	-	Ω
		negative transient	-	1.3	-	Ω
V _{CL(ch)} trt(pos	 positive transient channel clamping voltage 	V_{esd} = 8 kV HBM; T_{amb} = 25 °C	[2] _	8	-	V

Table 4 ~ otoricti

[1] This parameter is guaranteed by design.

[2] Human Body Model according to JESD22-A-J114D.

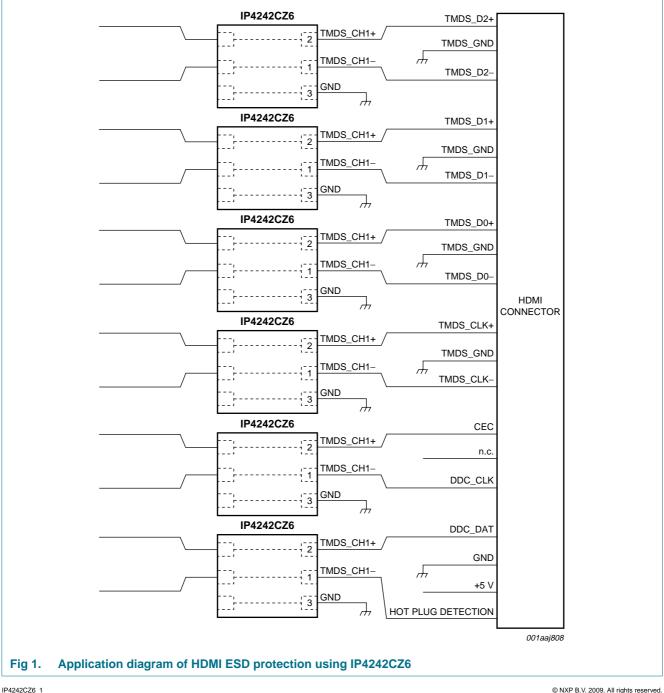
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Application information 6.

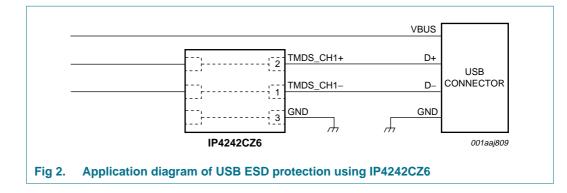
The IP4242CZ6 is designed mainly to provide high-level ESD protection for high-speed serial data buses such as HDMI, DVI, DisplayPort, USB2.0 and other LVDS data lines.

It is recommended that when designing the printed-circuit board, careful consideration is given to impedance matching, and signal coupling.

An basic application diagram for the ESD protection of an HDMI interface is shown in Figure 1, and a USB interface in Figure 2.



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7. Package outline

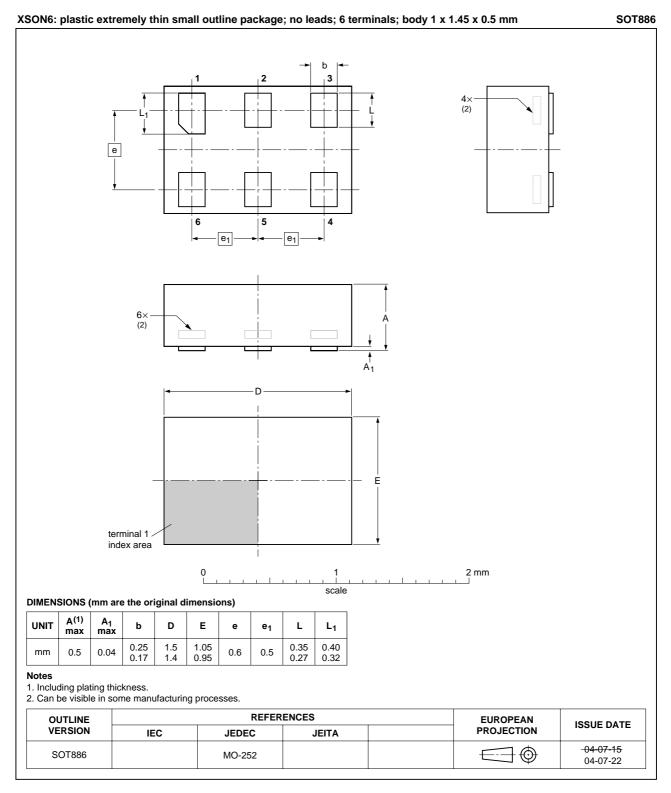


Fig 3.Package outline SOT886 (XSON6)

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8. Abbreviations

Table 5.	Abbreviations
Acronym	Description
DVD	Digital Versatile Disc
DVI	Digital Visual Interface
ESD	ElectroStatic Discharge
HBM	Human Body Model
HDMI	High-Definition Multimedia Interface
LVDS	Low-Voltage Differential Signaling
RoHS	Restriction of Hazardous Substances
TMDS	Transition Minimized Differential Signaling
USB	Universal Serial Bus
UTLP	Ultra-Thin Leadless Package

9. Revision history

Table 6. Revision his	story			
Document ID	Release date	Data sheet status	Change notice	Supersedes
IP4242CZ6_1	20090312	Product data sheet	-	-

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10. Legal information

10.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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